



IFW

**PATENT APPLICATION**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of

Docket No: Q85154

Takuo FUNAYA, et al.

Appln. No.: 10/516,708

Group Art Unit: 2841

Confirmation No.: 6730

Examiner: Lynne Renee Edmondson

Filed: December 3, 2004

For: SOLDER AND PACKAGE USING THE SAME

**AMENDMENT UNDER 37 C.F.R. § 1.111**

**MAIL STOP AMENDMENT**

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Sir:

In response to the Office Action dated October 24, 2005, please amend the above-identified application as follows on the accompanying pages.

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